

Final Product/Process Change Notification Document #: FPCN20886 Issue Date: 29 April 2015

Title of Chang	e:	SOD-	123 devices Cu wire qualification at O	N Semicor	nduct	or, Leshan, China facility.					
Proposed first	ship date:	5 Aug	gust 2015								
Contact inform	mation:	Conta	act your local ON Semiconductor Sales	Office or	<cole< th=""><th>een.Long@onsemi.com ></th></cole<>	een.Long@onsemi.com >					
Samples:		Conta	act your local ON Semiconductor Sales	Office							
Additional Rel	liability Data:	Conta	act your local ON Semiconductor Sales	Office or	<zz.c< th=""><th>heng@onsemi.com ></th></zz.c<>	heng@onsemi.com >					
Type of notific	cation:	to im ON Se	plementation of the change. emiconductor will consider this chang	e approve	ed unl) sent to customers. FPCNs are issued 90 days prior ess specific conditions of acceptance are provided in contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>					
Change Part Id	dentification:		e expiration of this FPCN devices will y. Devices with Cu Wire will have date			with Cu Wire at ON Semiconductor's existing Leshan 1, 2015 or later.					
Change categ Wafer Fab C Assembly Ch Test Change	change nange		☐ Manufacturing Site Change/Addi ☐ Manufacturing Process Change ☐ Material Change	tion		Product specific change Datasheet/Product Doc change Shipping/Packaging/Marking Other:					
Sites Affected				Site	<u>e 2</u>						
External Foundry/Subcon site(s):											
China facility. The impacted these devices	luctor is pleased to	ently a	assembled at the ON Semiconductor Vire at the same site. There is no cha	Leshan, C	China 1	ne impacted devices at ON Semiconductor's Leshan, facility with Au Wire. At the expiration of this PCN, e outline or electrical performance of the parts they					
Reliability Data Summary:											
Qual vehicle :											
BAT54T1G											
Test	T: 1500 an anam	T:	Condition	Interva		Results					
HTRB	Tj=150C or operating Tj 80% V bias (JA108)			1008 H		0/231					
HTSL	Ta=150C, or 175C based on datasheet max TA storage			1008 H	rs	0/231					
IOL	Ta=+25°C, deltaT	j=100°	C max, 2min on/off for 15000 cyc	15000 Cycle		0/231					
тс	Temp = -65°C to	+150°C	c; for 1000 cycles (JA104B)	1000 C	ycle	0/231					
AC	Temp = +121°C;	RH =10	0%, (JA110)	96 Hrs		0/231					
H3TRB	Temp = +85°C; R	H = 859	%, 80% V bias (JA101)	1008 H	rs	0/231					
RSH	TS=260C, Tdwell	=10 se	c. (Jedec B-106)			0/90					

TEM001092 Rev. D Page 1 of 2



Final Product/Process Change Notification Document #: FPCN20886

Issue Date: 29 April 2015

MMSD103	T1G		
Test	Condition	Interval	Results
HTRB	Tj=150C or operating Tj 80% V bias (JA108)	1008 Hrs	0/231
HTSL	Ta=150C, or 175C based on datasheet max TA storage	1008 Hrs	0/231
IOL	Ta=+25°C, deltaTj=100°C max, 2min on/off for 15000 cyc	15000Cycle	0/231
TC	Temp = -65°C to +150°C; for 1000 cycles (JA104B)	1000 Cycle	0/231
AC	Temp = +121°C; RH =100%, (JA110)	96 Hrs	0/231
H3TRB	Temp = +85°C; RH = 85%, 80% V bias (JA101)	1008 Hrs	0/231
RSH	TS=260C, Tdwell=10 sec. (Jedec B-106)		0/90

Electrical Characteristic Summary:

Electrical Characteristics are not impacted.

List of Affected Standard Parts:

MMSD301T1G MMSD701T1G MMSD4148T3G MMSD4148T1G

TEM001092 Rev. D Page 2 of 2